

1c971 U.S. PTO
10/008049

11/13/01

U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM 10008049	FILING DATE 11/13/2001	CLASS 438	SUBCLASS 125	GAU 2842	EXAMINER D. LE
**APPLICANTS: Amagai Masazumi; Karashima Akira; 257 253 2					
**CONTINUING DATA VERIFIED:					
** FOREIGN APPLICATIONS VERIFIED:					
PG-PUB <input type="checkbox"/> DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO TI-33622	
TITLE : Copper-based chip attach for chip-scale semiconductor packages					

U.S. DEPT. OF COMM./PAT. & TM-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg. Print Fig.
<input type="checkbox"/> TERMINAL DISCLAIMER		Primary Examiner PREPARED FOR ISSUE Applicant Examiner	
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